

[SV TCL's Trio](#) is a reliable solution for advanced wafer testing challenges, specifically full array and parallel probing. We offer a complete line of vertical probe card products, each designed for your unique application.

- **20K+ Probes**
- **Flat or Pointed Tip Shapes**
- **Variety of Build Options**
 - High Density
 - Multiple Die
 - Matrix Array
- **Applications**
 - Flip Chip Bump
 - Memory
 - Microprocessor
 - Logic

The Trio also has the capability of utilizing a variety of Space Transformer (ST) interconnects. Available Space Transformers include Multi-Layer Organic/Multi-Layer Ceramic (MLO/MLC), Wired, Direct Attach and our newest ST innovation, the Modular Space Transformer™, an all-inclusive interconnect and contactor in one compact unit. It allows internal components, has excellent electrical performance, and is design flexible - all of which create a lower cost of probe card ownership.

Contact your [SV TCL & Associates Probe Company China Japan Europe](#) Representative so we can help you find the right Trio product for your vertical testing needs.